

# 1200V SiC Schottky Diode

# Q<sub>C</sub> Q<sub>C</sub> R<sub>F</sub>

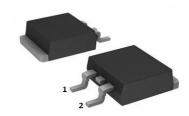
**GP2D005A120C** 

VDC 1200 V

22 nC 5 A

## Amp+™ Features

- High surge current capable
- Zero reverse recovery current
- · High bandwidth
- Fast, temperature-independent switching



## Amp+™ Benefits

- Unipolar rectifier
- Zero switching loss
- Higher efficiency
- Smaller heat sink
- Parallel devices with thermal stability

## Amp+™ Applications

- Motor drives
- Switch mode power supplies
- Power factor correction

Part #	Package	Marking
GP2D005A120C	TO-252-2L (DPAK)	2D005A120





Maximum Rating	Symbol	Conditions	Value	Unit
		T <sub>C</sub> =25 °C, T <sub>j</sub> =175 °C	17	
Continuous forward current	I <sub>F</sub>	T <sub>C</sub> =125 °C, T <sub>j</sub> =175 °C	10	^
		T <sub>C</sub> =150 °C, T <sub>j</sub> =175 °C	6	
Surge non-repetitive forward current		$T_{C}$ =25 °C, $t_{p}$ =8.3 ms	40	А
sine halfwave	I <sub>F,SM</sub>	$T_{\rm C}$ =150 °C, $t_{\rm p}$ =8.3 ms	25	
Non-repetitive peak forward current	I <sub>F,max</sub>	T <sub>C</sub> =25 °C, t <sub>p</sub> =10 μs	100	
-2.	∫i²dt	$T_{C}$ =25 °C, $t_{p}$ =8.3 ms	7	<b>A</b> 2
<i>i</i> <sup>2</sup> <i>t</i> value	Ji-at	$T_{C}$ =150 °C, $t_{p}$ =8.3 ms	3	A <sup>2</sup> s
Repetitive peak reverse voltage	$V_{RRM}$	T <sub>j</sub> =25 °C	1200	V
Diode dv/dt ruggedness	dv/dt	Turn-on slew rate, repetitive	50	V/ns
Power dissipation	P <sub>tot</sub>	T <sub>C</sub> =25 °C	100	W
Operating & storage temperature	T <sub>J</sub> , T <sub>storage</sub>	Continuous	-55175	°C
Soldering temperature	T <sub>solder</sub>	Wave soldering leads	260	°C
Mounting torque		M3 Screw	1	N-m

## Electrical Characteristics, at T<sub>i</sub>=25 °C, unless otherwise specified

Static Characteristics	Symbol	Conditions	Values			Unit
Static Gliaracteristics	Symbol	Symbol	min.	typ.	max.	Oilit
DC blocking voltage	$V_{DC}$	I <sub>R</sub> =0.1mA	1200	-	-	
Diode forward voltage	V <sub>F</sub>	I <sub>F</sub> =5A, T <sub>j</sub> =25 °C	-	1.60	1.80	V
	VF	I <sub>F</sub> =5A, T <sub>j</sub> =175 °C	-	2.20	2.70	
Reverse current	1	V <sub>R</sub> =1,200V, T <sub>j</sub> =25 °C	-	1.0	10	A
Reverse current	IR	V <sub>R</sub> =1,200V, T <sub>j</sub> =175 °C	-	30	300	μΑ

# **1200V SiC Schottky Diode**

## $Amp + ^{TM}$

## GP2D005A120C

рF

Parameter	Symbol	Conditions	Values		Unit	
r ai ailletei	Symbol	Conditions	min.	typ.	max.	Oill
AC Characteristics						
Total capacitive charge	$Q_{C}$	V <sub>R</sub> =1,200V, T <sub>j</sub> =25 °C	-	22	-	nC
Switching time	t <sub>C</sub>	di <sub>F</sub> /dt=200 A/μs T <sub>j</sub> =150 °C	-	-	<10	ns

V<sub>R</sub>=1 V, f=1 MHz

V<sub>R</sub>=600V, f=1 MHz

V<sub>R</sub>=1,200V, f=1 MHz

С

# Thermal Characteristics

Total capacitance

Thermal resistance, junction-case	$R_{thJC}$	Package (flange) mount	1	1.50	-	°C/W

## **Typical Performance**

Fig. 1 Forward Characteristics (parameterized on T<sub>i</sub>)

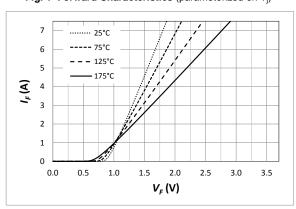


Fig. 2 Reverse Characteristics (parameterized on Tj)

317

19

18

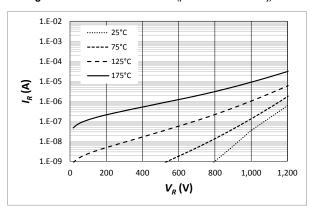


Fig. 3 Power Derating

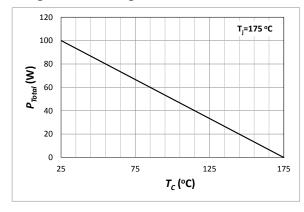


Fig. 4 Current Derating

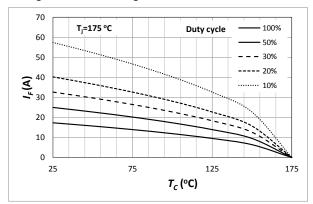


Fig. 5 Capacitance

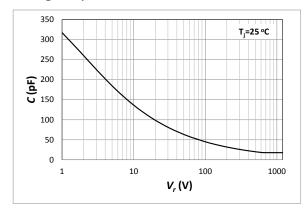
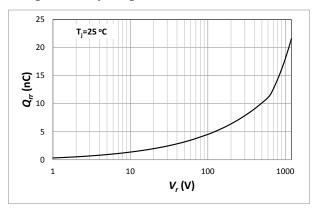


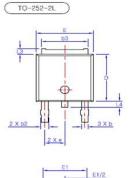
Fig. 6 Recovery Charge

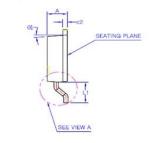


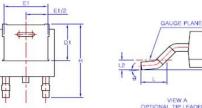
MAX

## **Package Dimensions**

## Package TO-252-2L (DPAK)







A	2.20	2.30	2.40		
A1 (▼)	0.00	_	0.127		
b	0.66	0.76	0.86		
b2	-0		0.96		
b3	5.04	5.34	5.64		
c2	0.40	0.50	0.60		
D	5.90	6.10	6.30		
D1	(4.75)				
Ε	6.40	6.60	6.80		
E1	(5.04)				
e	2.30 BSC				
Н	9.20	9.50	9.80		
L	1.27	1.47	1.67		
L1	2.50	2.70	2.90		
L2	0.508 BSC				
L3	0.50	0.70	0.90		
L4	0.60	0.80	1.00		
9	0°	-	10°		
91	(5°)				

NOM

MIN

### (\* NOTE

- 1. THESE DIMENSIONS DO NOT INCLUDE PROTRUSIONS OF THE MOLD. 2. THE "()" MARK IS THE REFERENCE 3. COPLANARITY: MAX. () IONNO 4. THE "L4" SYMBOL IS A PROTRUSION OF THE LEAD FRAME.

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented March, 2013. RoHS Declarations for this product can be obtained from the Product Documentation sections of www.gptechgroup.com.

REACH Compliance
REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemi- cal Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact our office at GPTG Headquarters in Lake Forest, California to insure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

This product has not been designed or tested for use in, and is not intended for use in, applications implanted into the human body nor in applications in which failure of the product could lead to death, personal injury or property damage, including but not limited to equipment used in the operation of nuclear facilities, life-support machines, cardiac defibrillators or similar emergency medical equipment, aircraft navigation or communication or control systems, or air traffic control.

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